

P

PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

| APPL NUM | FILING DATE | CLASS | SUBCLASS | GAU | EXAMINER |
|----------|-------------|-------|----------|------|----------|
| 10071320 | 02/08/2002 | 420 | 551 | 1742 | Jp |

**APPLICANTS: Habu Kazutaka; Takeda Naoko,

**CONTINUING DATA VERIFIED:
THIS APPLICATION IS A DIV OF 09/066,851 04/28/1998

** FOREIGN APPLICATIONS VERIFIED:
JAPAN P08-336978 12/17/1996
JAPAN P09-348212 12/17/1997

| | | | |
|---|---|--|--------------------|
| PG-PUB | DO NOT PUBLISH <input type="checkbox"/> | RESCIND <input type="checkbox"/> | ATTORNEY DOCKET NO |
| Foreign priority claimed | | <input type="checkbox"/> yes <input type="checkbox"/> no | 09792909-5360 |
| 35 USC 119 conditions met | | <input type="checkbox"/> yes <input type="checkbox"/> no | |
| Verified and Acknowledged Examiner's initials | | | |
| TITLE : Method to manufacture lead-free solder material having good wettability | | | |

U.S. DEPT. OF COMM. PAT. & TM. (PRO-475L) (Rev. 12-94)

| | | | | |
|--|-----------|--------------------|----------------|----------------------|
| NOTICE OF ALLOWANCE MAILED | | Assistant Examiner | CLAIMS ALLOWED | |
| | | | Total Claims | Print Claim for O.G. |
| ISSUE FEE | | DRAWING | | |
| Amount Due | Date Paid | Sheets Drwg. | Figs. Drwg. | Print Fig. |
| TERMINAL DISCLAIMER | | Primary Examiner | | Application Examiner |
| PREPARED FOR ISSUE | | | | |
| WARNING: The information disclosed hereto may be restricted. Unauthorized disclosure may be prohibited by the United States Code Title 35, Sections 122, 181 and 368. Possession outside the U.S. Patent & Trademark Office is restricted to authorized employees and contractors only. | | | | |

FILED WITH: DISK (CRF) CD-ROM
(Attached in pocket on right inside flap)